ACKNOWLEDGEMENT RECEIPT

Electronic Version 1.1 Stylesheet Version v1.1.1

Title of Invention

EFS ID:

HIGH-PRESSURE PROCESSING CHAMBER FOR A SEMICONDUCTOR WAFER

Submision Type: Information Disclosure

Statement

Application Number:

10/680783

88501

Server Response:

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First Named Applicant:

William Jones

Attorney Docket Number:

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File Listing:

Doc. Name	File Name	Size (Bytes)	Date
		, , ,	Produced
			(yyyymmdd)
us-ids	SSI04001-usidst.xml	3804	2005-07-19
us-ids	us-ids.dtd	7763	2005-07-19
us-ids	us-ids.xsl	12026	2005-07-19
package-data	SSI04001-pkda.xml	1706	2005-07-19
package-data	package-data.dtd	27025	2005-07-19
package-data	us-package-data.xsl	19263	2005-07-19
	Total files size	71587	

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